Ultra Small Temperature Switch with Pin-Selectable Hysteresis

The MAX6501 and MAX6502 are SOT–23 temperature switches that require no external components and the design is facilitated with factory–programmed temperature thresholds. A choice of factory–trimmed temperature trip points are available. Pin selectable hysteresis of +2°C or +10°C allows flexibility to the design. These parts typically consume only 17 μ A of current and operate over the entire -55°C to +125°C temperature range while offering accuracies of ±0.5°C (typ) and ±4°C (max).

The MAX6501 has an open drain, active low output, meant for microprocessor reset control. The MAX6502 has a CMOS, active high output designed to drive a logic level MOSFET to turn on a fan or heater element.

The MAX6501/6502 are aimed for hot-temperature monitoring $(+45^{\circ}C \text{ to } +115^{\circ}C)$. These devices assert a logic signal when the temperature goes above the threshold.

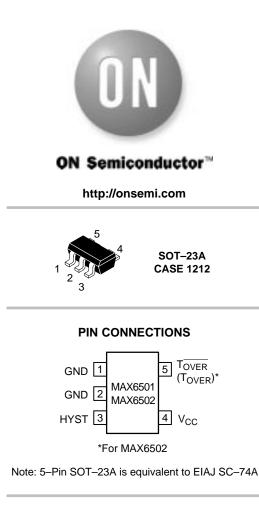
The MAX6501 and MAX6502 are offered in five standard temperature thresholds. Available in 5–Pin SOT–23A packages, these parts are ideal for applications requiring high integration, small size, low power and low installed cost.

Features

- 5–Pin SOT–23A
- Factory–Programmed Thresholds from +45°C to +115°C in 10°C Increments
- Pin–Selectable +2°C or +10°C Hysteresis
- $\pm 0.5^{\circ}$ C (Typ) Threshold Accuracy Over Full Temperature Range
- No External Components Required
- 17 µA Supply Current

Typical Applications

- Thermal Management in PCs and Servers
- Over Temperature Fail Safe Circuits
- Simple Fan Controller
- Temperature Alarms
- Projectors/Printers
- Notebook Computers
- Network Boxes



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 9 of this data sheet.

ABSOLUTE MAXIMUM RATINGS*

Rating	Symbol	Value	Unit
Supply Voltage	V _{CC}	-0.3 to +7.0	V
TOVER (MAX6501)	-	-0.3 to +7.0	V
TOVER (MAX6502)	-	–0.3 to (V _{CC} +0.3)	V
All Other Pins	-	–0.3 to (V _{CC} +0.3)	V
Input Current (All Pins)	-	20	mA
Output Current (All Pins)	-	20	mA
Operating Temperature Range	-	-55 to +125	°C
Storage Temperature Range	T _{stg}	-65 to +165	°C
Lead Temperature (Soldering, 10 seconds)	-	+300	°C
Power Dissipation (T _A = +70°C) (Derate 7.1 mW/°C Above +70°C)	-	571	mW

*Static-sensitive device. Unused devices must be stored in conductive material. Protect devices from static discharge and static fields. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to Absolute Maximum Rating Conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS $V_{CC} = +2.7 \text{ V}$ to +5.5 V, $R_{PULL-UP} = 100 \text{ K}\Omega$ (MAX6501 only), $C_{COUPLING} = 100 \text{ pF}$ from V_{CC} to GND, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_A = +25^{\circ}\text{C}$.

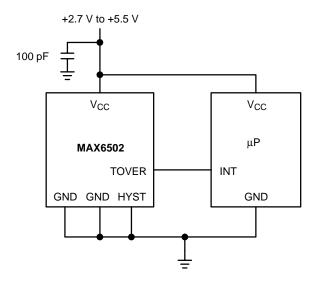
Characteristics	Test Conditions	Symbol	Min	Тур	Max	Unit
Supply Voltage Range	-	V _{CC}	2.7	-	5.5	V
Supply Current	-	I _{CC}	-	17	40	μΑ
Temperature Threshold Accuracy (Note 1.)	+45°C to +65°C +75°C to +115°C	ΔT _{TH}	-4.0 -6.0	± 0.5 ± 0.5	4.0 6.0	°C
Temperature Threshold Hysteresis	HYST = GND HYST = V _{CC}	T _{HYST}		2.0 10		°C
HYST Input Threshold	-	V _{IH}	0.8 x V _{CC}	-	-	V
HYST Input Threshold	-	V _{IL}	-	-	0.2 x V _{CC}	V
Output Voltage High	$I_{SOURCE} = 500 \ \mu\text{A}, \ V_{CC} > 2.7 \ V \\ (MAX6502 \ Only) \\ I_{SOURCE} = 800 \ \mu\text{A}, \ V_{CC} > 4.5 \ V \\ (MAX6502 \ Only) \\ \end{cases}$	V _{OH}	0.8 x V _{CC} V _{CC} –1.5	_	-	V
Output Voltage Low	$\begin{array}{l} I_{SINK} = 1.2 \text{ mA}, V_{CC} > 2.7 \text{ V} \\ I_{SINK} = 3.2 \text{ mA}, V_{CC} > 4.5 \text{ V} \end{array}$	V _{OL}		-	0.3 0.4	V
Open–Drain Output Leakage Current	V _{CC} = 2.7 V, V _{TOVER} = 5.5 V (MAX6501 Only)	-	-	10	-	nA

The MAX6501 and MAX6502 are available with internal, factory-programmed temperature trip thresholds from +45°C to +115°C in +10°C increments.

PIN DESCRIPTION

MAX6501	MAX6502	Name	Description
1,2	1,2	GND	Ground. Ground both pins together close to the chip. Pin 2 provides the lowest thermal resistance to the die.
3	3	HYST	Hysteresis Input. Connect HYST to GND for +2°C hysteresis, or connect to V_{CC} for +10°C hysteresis.
4	4	V _{CC}	Supply Input (+2.7 V to +5.5 V). Recommend 100 pF or greater Coupling capacitor from V _{CC} to GND.
5	-	TOVER	Open–Drain, Active–Low Output. TOVER goes low when the die temperature exceeds the factory–programmed temperature threshold. Connect to a 100 K Ω pull–up resistor. May be pulled up to a voltage higher than V _{CC} .
-	5	TOVER	Push/Pull Active–High Output. TOVER goes high when the die temperature exceeds the factory–programmed temperature threshold.





DETAILED DESCRIPTION

The MAX6501 and MAX6502 integrate a temperature sensor with a factory–programmed threshold switch. A logic signal is asserted when the die temperature crosses the factory programmed threshold. An external hysteresis input pin allows the user to select either 2°C or 10°C hysteresis to give further flexibility to the design of the application. The MAX6501 and MAX6502 are intended for a temperature range from 45°C to 115°C in a 10°C increment. The MAX6501 has an open drain output and the MAX6502 has a push/pull output stage.

The MAX6501 is intended for applications with a microprocessor reset input. The MAX6502 is intended for applications of turning on a fan or heater element.

Hysteresis Input

To prevent the output from "chattering" at or near the trip point temperature, a selectable HYST input pin is provided. Hysteresis can be externally selected at 2°C (HYST = GND) or 10°C (HYST = V_{DD}) by means of the CMOS compatible HYST input pin. Do not let the HYST pin float as this could cause increase supply current. The hysteresis does not depend on the part's programmed trip threshold.

Table 1. F	actory-Programmed	Threshold	Range
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Part Number	Threshold (T _{TH}) Range
MAX6501	$+45^{\circ}C < T_{TH} < +115^{\circ}C$
MAX6502	$+45^{\circ}C < T_{TH} < +115^{\circ}C$

Thermal Considerations

With a very low 17 μ A supply current, the MAX6501 and MAX6502 dissipates very little power. Thus, the die temperature is basically the same as the package temperature. To minimize the error in temperature readings, the load current should be limited to a few milliamps. As an example, the typical thermal resistance of a 5–Pin SOT–23A package is 140°C/W. If the MAX6501 had to sink 1.0 mA, and the output voltage is guaranteed to be less than 0.3 V, then an additional 0.3 mW of power is dissipated within the IC. This corresponds to a 0.042°C rise in die temperature in the 5–Pin SOT–23A.

Temperature monitoring accuracy depends on the thermal resistance between the device being monitored and the temperature switch die. Heat flows primarily through the leads onto the die. Pin 2 provides the lowest thermal resistance to the die. To achieve the best temperature monitoring results, the MAX6501 and MAX6502 should be placed closest to the device being monitored. In addition, a short and wide copper trace from Pin 2 to the device should be used. In some cases, the 5–Pin SOT–23A

package can be placed directly under the socketed microprocessor for improved thermal contact.

APPLICATIONS

The MAX6501 has an open drain output and is therefore intended to interface as a microprocessor reset input. Moreover, the combination of these two devices can be used to implement a temperature window alarm by wire–ORing the outputs and using an external pull up resistor. (See Figure 1)

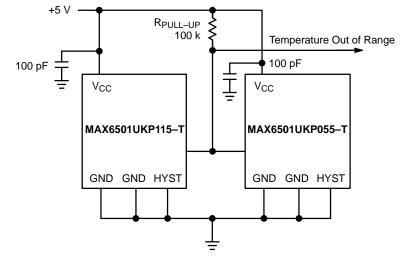


Figure 1. Over and Under Temperature Alarm

The MAX6502 can be used to control a DC fan. The fan turns on when the sensed temperature rises above the factory set threshold and remains on until the temperature falls below threshold minus the hysteresis selected. An additional fail safe measure could be designed by using a second MAX6502 with a higher temperature threshold to alert the user of an impending thermal shutdown, should the temperature continue to rise. (See Figure 2)

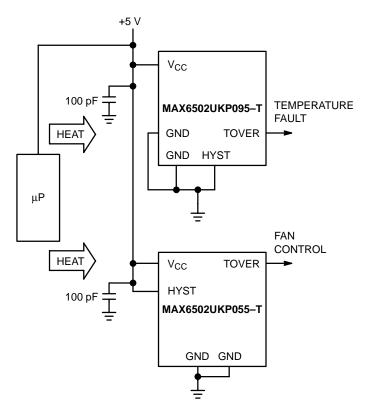
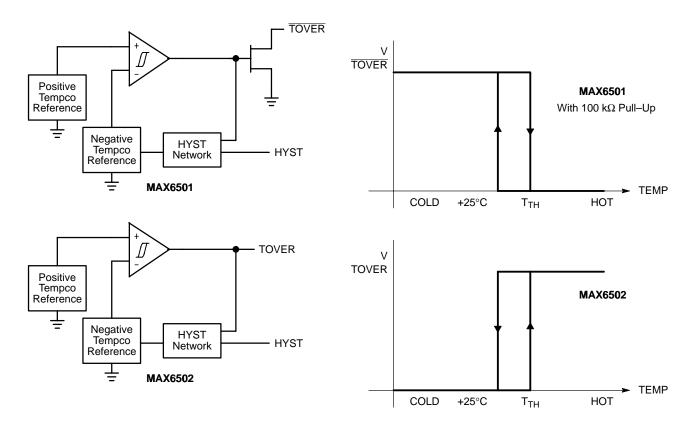
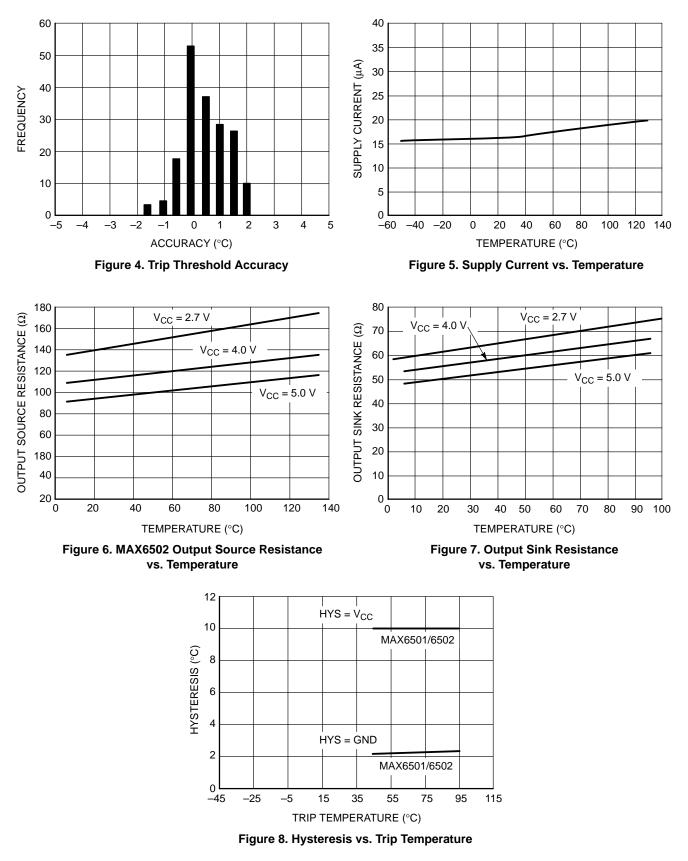


Figure 2. Fan Control Circuit with Over Temperature Alert

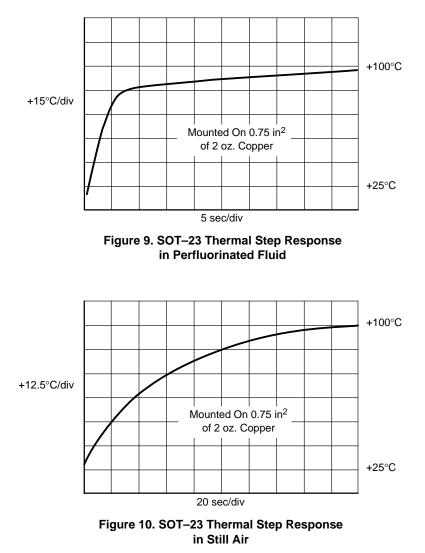




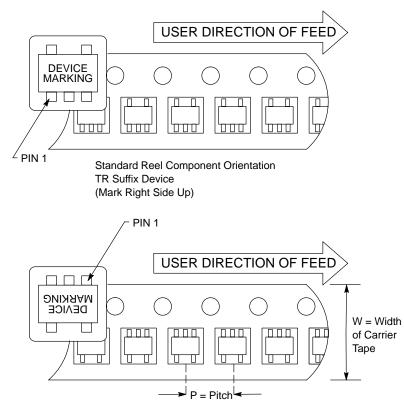
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



Component Taping Orientation for 5–Pin SOT–23A (EIAJ SC–74A) Devices



Reverse Reel Component Orientation RT Suffix Device (Mark Upside Down)

Carrier Tape, Reel Size, and Number of Components Per Reel

Package	Carrier Width (W)	Pitch (P)	Part Per Full Reel	Reel Size
SOT–23A	8 mm	4 mm	3000	7 inches

MARKING DIAGRAM



and (2) = Two Letter Part Number Codes
(3) = Year and Two–Month Period Code
(4) = Lot ID Number

ORDERING INFORMATION

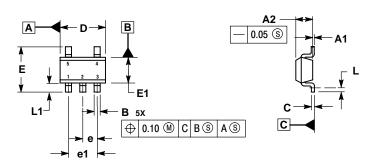
Device	Package	Standard Temperature Threshold	Output Stage	Marking ① and ②	Shipping
MAX6501UKP045-T		45°C	Open Drain	HA	
MAX6501UKP055-T*		55°C	Open Drain	HB	
MAX6501UKP065-T		65°C	Open Drain	HC	
MAX6501UKP075-T		75°C	Open Drain	HD	
MAX6501UKP085-T		85°C	Open Drain	HE	
MAX6501UKP095-T*		95°C	Open Drain	HF	
MAX6501UKP105-T		105°C	Open Drain	HG	
MAX6501UKP115-T*		115°C	Open Drain	HH	
MAX6502UKP045-T	5-Pin SOT-23A	45°C	Push/Pull	JA	3000 Units Tape and Reel
MAX6502UKP055-T*		55°C	Push/Pull	JB	
MAX6502UKP065-T		65°C	Push/Pull	JC	
MAX6502UKP075-T		75°C	Push/Pull	JD	
MAX6502UKP085-T		85°C	Push/Pull	JE	
MAX6502UKP095-T*		95°C	Push/Pull	JF	
MAX6502UKP105-T		105°C	Push/Pull	JG	
MAX6502UKP115-T*		115°C	Push/Pull	JH	

*Default: Contact your ON Semiconductor sales representative for other temperature threshold options.

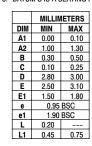
<u>Notes</u>

PACKAGE DIMENSIONS

SOT-23 CASE 1212-01 ISSUE O



NOTES: 1. DIMENSIONS ARE IN MILLIMETERS. 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994. 3. DATUM C IS A SEATING PLANE.



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